IPC ASSOCIATION ELECTRONICS	Material Com © Copyright 2005. international and Pa	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.		nder both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowel parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				Materials and	ials and Mfg Information			
upplier	r Information													
Company name* Company unique ID				nique ID	E ID Unique II		Jnique ID Autho	nique ID Authority			Response Date*			
nsemi											2023-06-08			
ontact Na	ame	Title - Contact			F	Phone - Contact*				Email - Contact*				
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uthorized	d Representative*	Title - Representative			F	Phone - Representative*			Emai	Email - Representative*				
Product-Env-Stewards Prod				Product Enviro Compliance			NA			Prod	Product-Env-Stewards@onsemi.com			
	Requester Item Number	Mfr Iten	n Number	Mfr Item Name			Effective Date	Version	Manufacturing S	ite	Weight*	UOM	Unit Type	
	FSQ110 FPS FOR DVDP/ST		STB		2023-06-08		PH4		478.437	mg	Each			
	cturing Process Information		Terminal Base	Alloy	-STD-020 MS	I Pating	Peak Proce	ss Rody Tem	perature May Time a	t Peak Tempe	rature Numb	er of Reflow Cv	cles	
	8		CU Alloy NA			or Kanng		Peak Process Body Temperature Max Time at Pe		1.	k Temperature Number of Reflow Cycles seconds 3			
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RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Isability and the Company's remedies for issues that arise regarding information the Supplier provides in this fo											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.6	mg	Supplier	Silicon (Si)	7440-21-3		1.6	mg
Die Attach	3.0	mg	Supplier	Silver (Ag)	7440-22-4		2.25	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.75	mg
Lead Frame	137.787	mg	Supplier	Silver (Ag)	7440-22-4		0.69	mg
			Supplier	Zinc (Zn)	7440-66-6		0.193	mg
			Supplier	Iron (Fe)	7439-89-6		3.6	mg
			Supplier	Copper (Cu)	7440-50-8		133	mg
			Supplier	Phosphorus (P)	7723-14-0		0.304	mg
Mold Compound-Black	321.0	mg		Phenolic Resin	proprietary data		25.68	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		25.68	mg
			Supplier	Carbon Black (C)	1333-86-4		1.605	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		268.035	mg
Plating	9.05	mg	Supplier	Tin (Sn)	7440-31-5		9.05	mg
Wire Bond - Au	6.0	mg	Supplier	Gold (Au)	7440-57-5		6	mg